

## N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

## DESCRIPTION

The  $\mu$ PA1873 is a switching device which can be driven directly by a 2.5 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

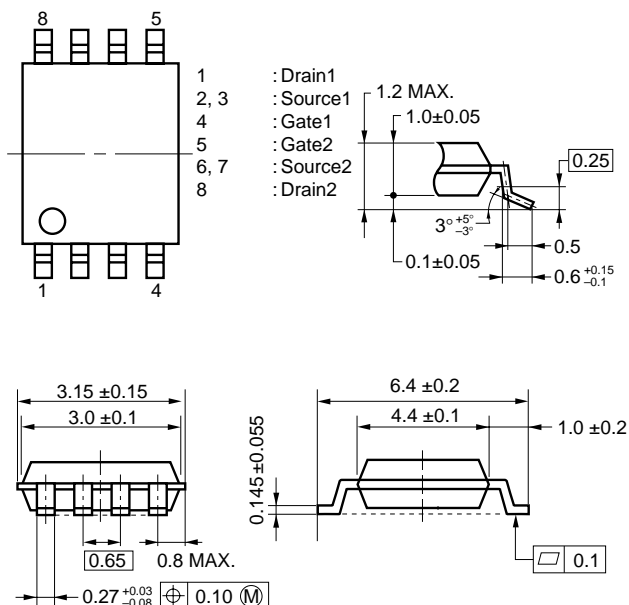
## FEATURES

- 2.5 V drive available
- Low on-state resistance
  - $R_{DS(on)1} = 23.0 \text{ m}\Omega \text{ MAX.}$  ( $V_{GS} = 4.5 \text{ V}$ ,  $I_D = 3.0 \text{ A}$ )
  - $R_{DS(on)2} = 24.0 \text{ m}\Omega \text{ MAX.}$  ( $V_{GS} = 4.0 \text{ V}$ ,  $I_D = 3.0 \text{ A}$ )
  - $R_{DS(on)3} = 28.0 \text{ m}\Omega \text{ MAX.}$  ( $V_{GS} = 3.1 \text{ V}$ ,  $I_D = 3.0 \text{ A}$ )
  - $R_{DS(on)4} = 29.0 \text{ m}\Omega \text{ MAX.}$  ( $V_{GS} = 2.5 \text{ V}$ ,  $I_D = 3.0 \text{ A}$ )
- Built-in G-S protection diode against ESD

## ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1873GR-9JG	Power TSSOP8

**PACKAGE DRAWING (Unit : mm)**



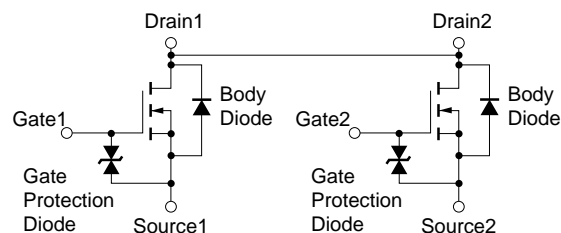
### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Drain to Source Voltage ( $V_{GS} = 0\text{ V}$ )	$V_{DSS}$	20	V
Gate to Source Voltage ( $V_{DS} = 0\text{ V}$ )	$V_{GSS}$	$\pm 12$	V
Drain Current (DC) ( $T_A = 25^\circ\text{C}$ )	$I_{D(DC)}$	$\pm 6.0$	A
Drain Current (pulse) <sup>Note1</sup>	$I_{D(pulse)}$	$\pm 80$	A
Total Power Dissipation (2 unit) <sup>Note2</sup>	$P_T$	2.0	W
Channel Temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	$-55\text{ to }+150$	$^\circ\text{C}$

- Notes 1.**  $PW \leq 10 \mu s$ , Duty Cycle  $\leq 1\%$   
**2.** Mounted on ceramic substrate of  $5000 \text{ mm}^2 \times 1.1 \text{ mm}$

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

### EQUIVALENT CIRCUIT

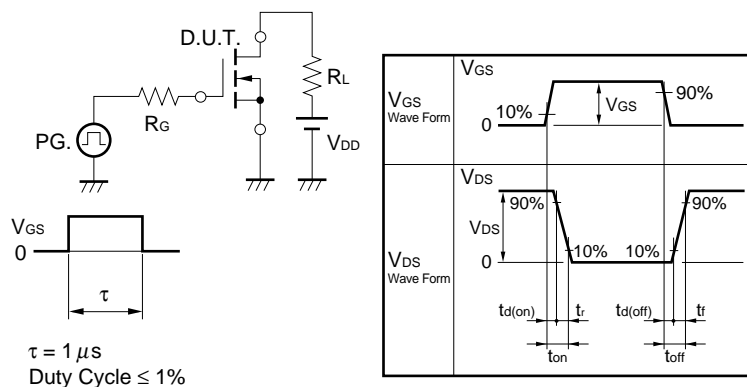


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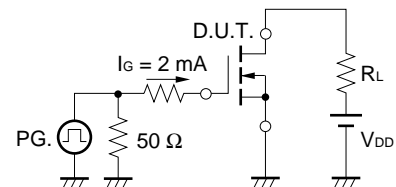
# ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			10	μA
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±12 V, V <sub>DS</sub> = 0 V			±10	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.0 mA	0.5	1.0	1.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.0 A	5.0			S
Drain to Source On-state Resistance	R <sub>DS(on)1</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3.0 A	13.0	18.0	23.0	mΩ
	R <sub>DS(on)2</sub>	V <sub>GS</sub> = 4.0 V, I <sub>D</sub> = 3.0 A	14.0	19.0	24.0	mΩ
	R <sub>DS(on)3</sub>	V <sub>GS</sub> = 3.1 V, I <sub>D</sub> = 3.0 A	14.5	21.5	28.0	mΩ
	R <sub>DS(on)4</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 3.0 A	15.0	24.5	29.0	mΩ
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10 V		705		pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V		205		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz		145		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 10 V, I <sub>D</sub> = 3.0 A		60		ns
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 4.0 V		310		ns
Turn-off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> = 10 Ω		380		ns
Fall Time	t <sub>f</sub>			420		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = 16 V		9.0		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = 4.0 V		2.0		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = 6.0 A		4.0		nC
Body Diode Forward Voltage	V <sub>F(S-D)</sub>	I <sub>F</sub> = 6.0 A, V <sub>GS</sub> = 0 V		0.84		V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 6.0 A, V <sub>GS</sub> = 0 V		480		ns
Reverse Recovery Charge	Q <sub>rr</sub>	di/dt = 50 A/μs		1200		nC

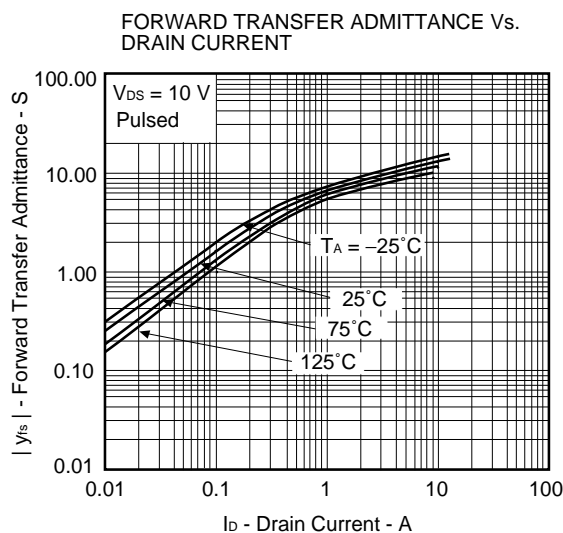
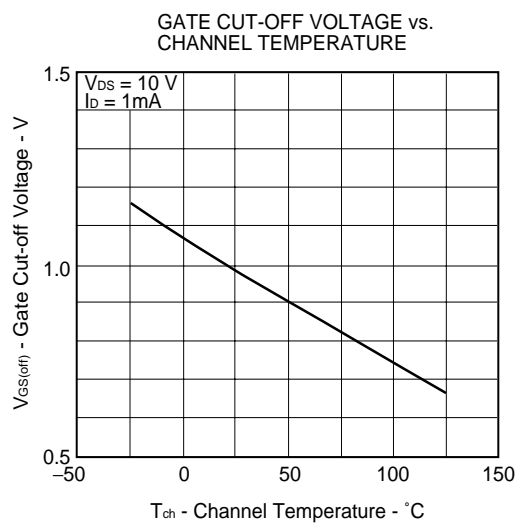
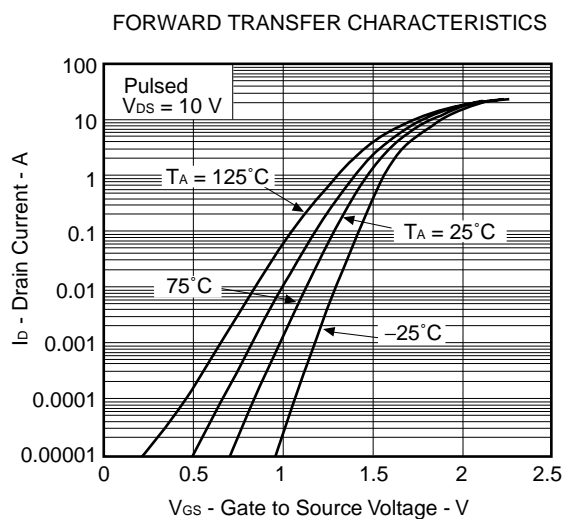
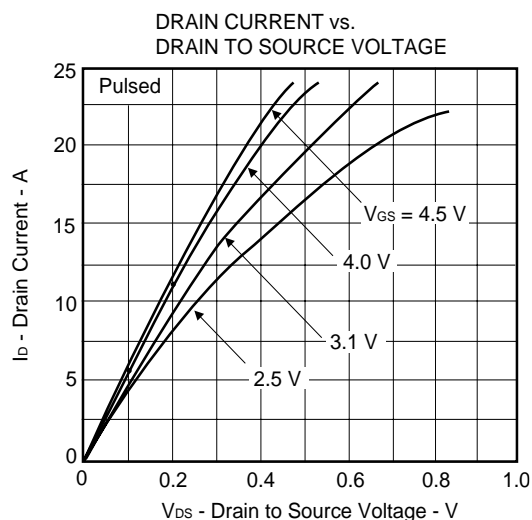
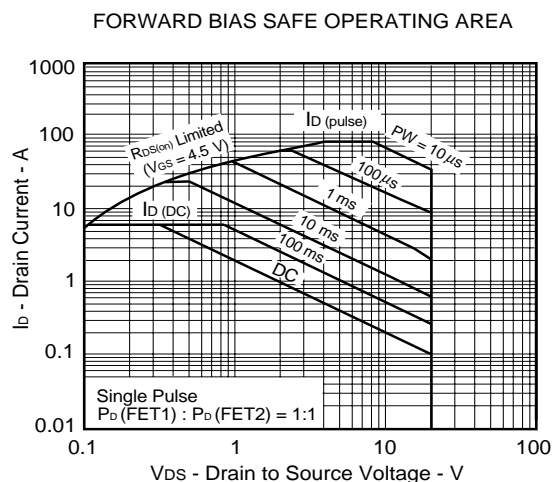
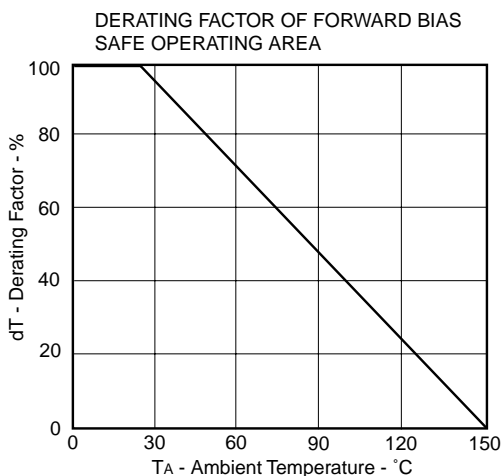
## TEST CIRCUIT 1 SWITCHING TIME

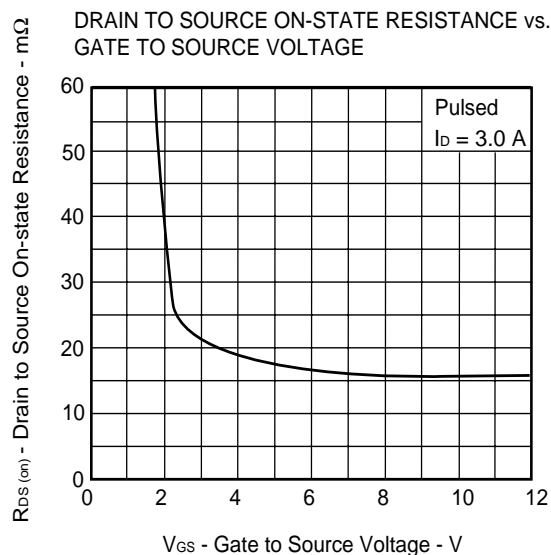
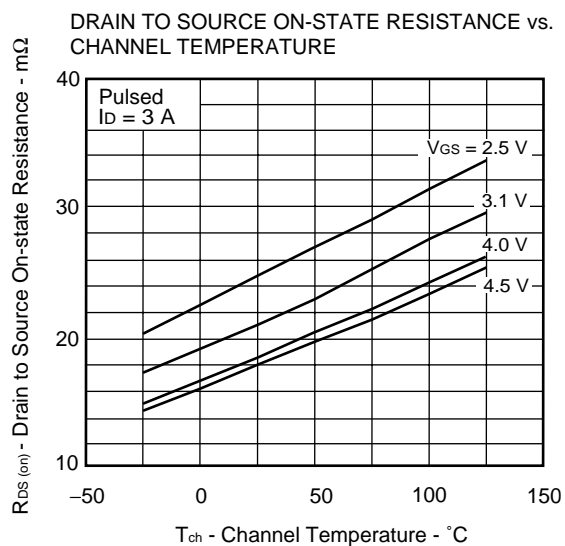
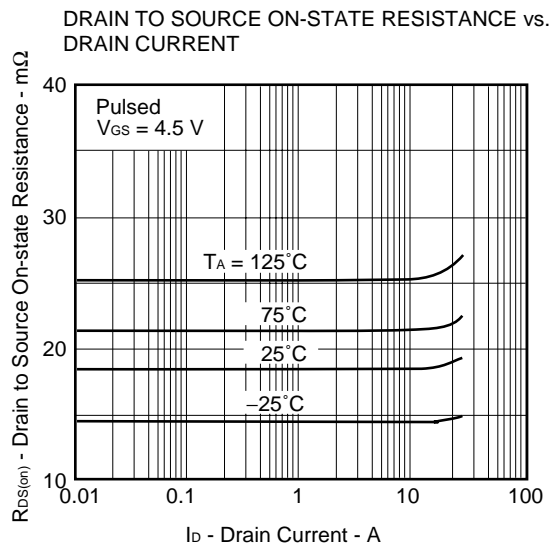
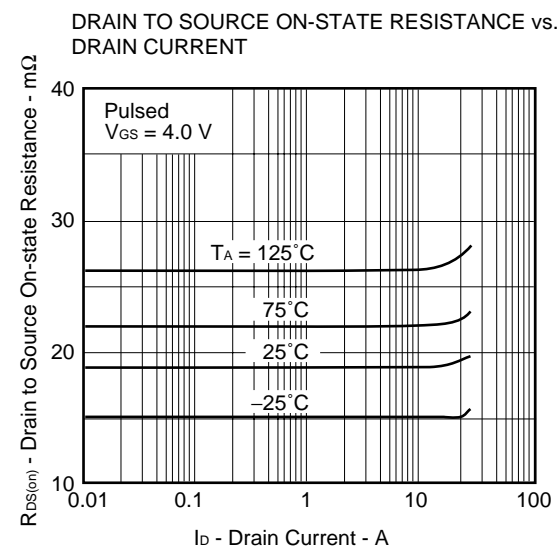
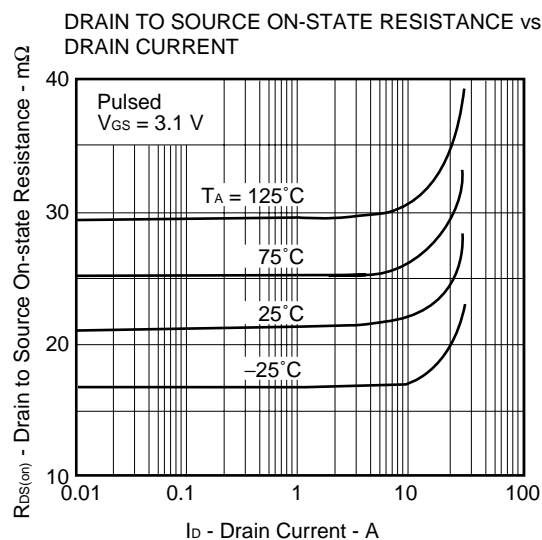
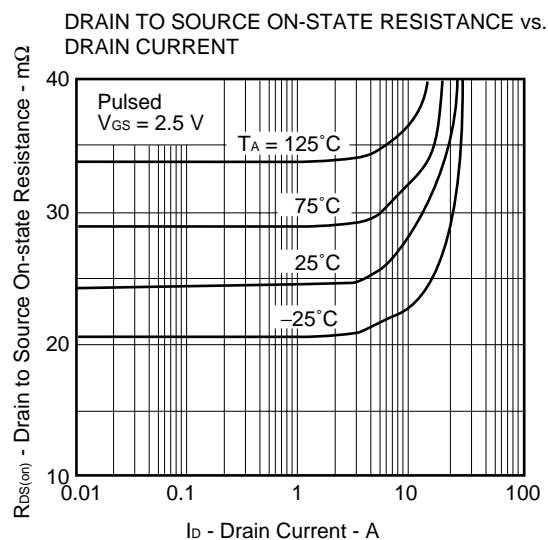


## TEST CIRCUIT 2 GATE CHARGE

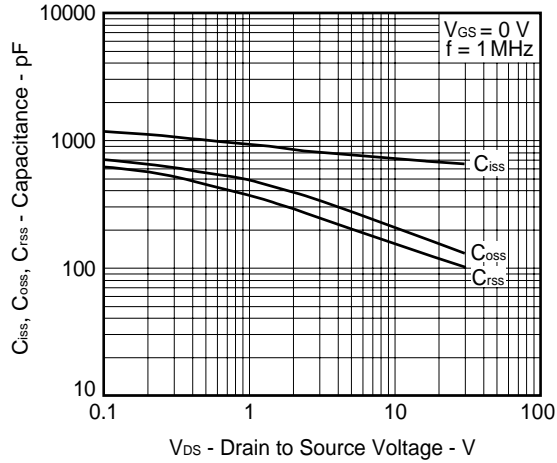


TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ )

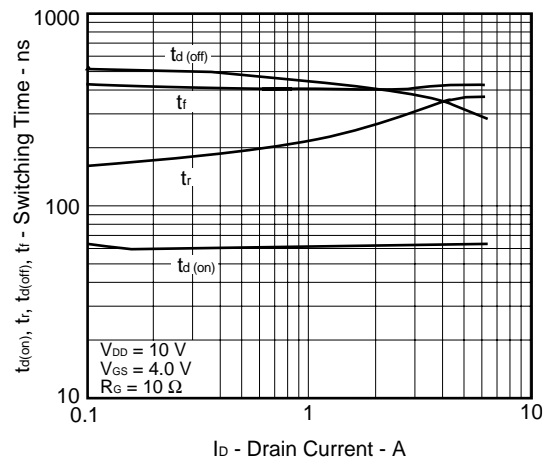




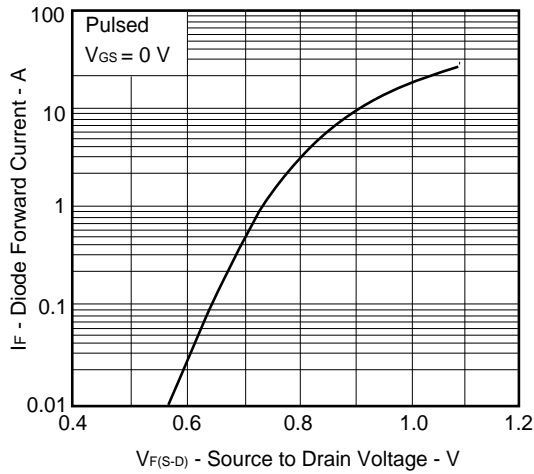
CAPACITANCE vs.  
DRAIN TO SOURCE VOLTAGE



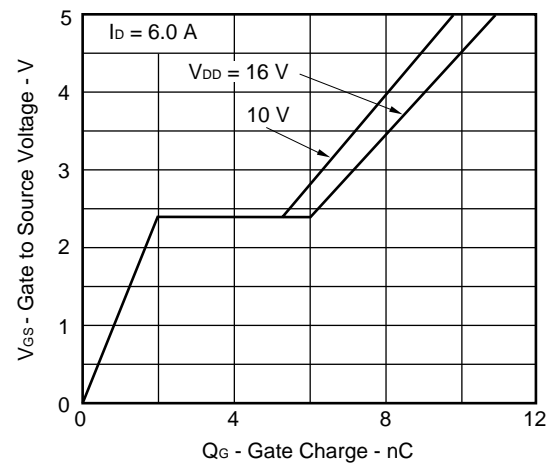
SWITCHING CHARACTERISTICS



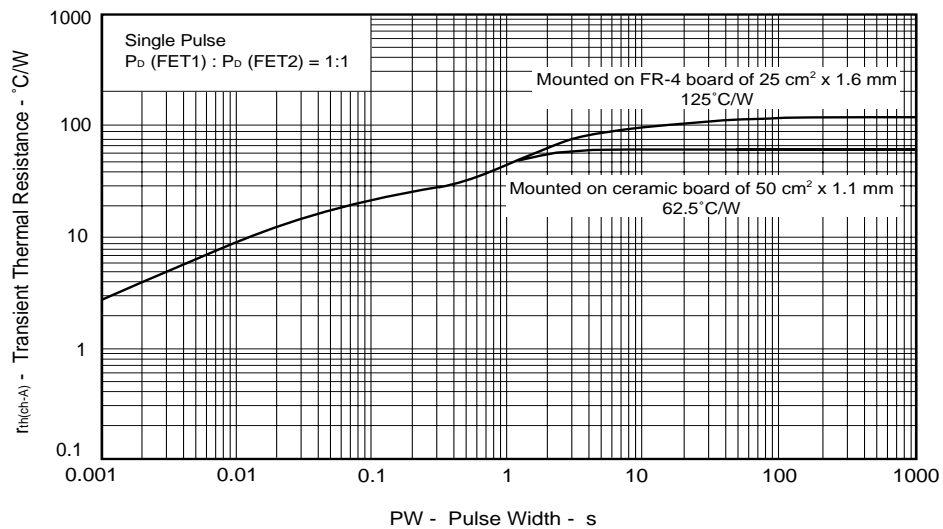
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



DYNAMIC INPUT/OUTPUT CHARACTERISTICS



TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



[MEMO]

[MEMO]

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